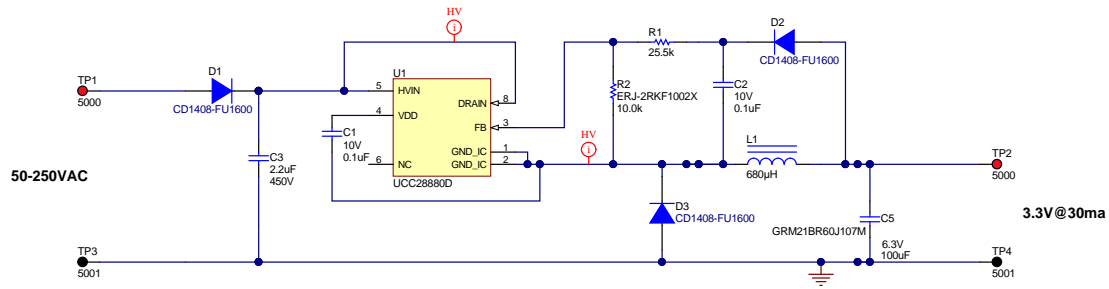


Notes:

1. D2 footprint on PCB is SOD882, larger package diode is actually used



PCB Number: PMP21750
PCB Rev: A

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Number: PMP21750	Rev: A	Designed for: Public Release	Mod. Date: 11/29/2018
SVN Rev: N3 in version control	Assembly Variant: 001	Project Title: UCC28880 High-side Buck Converter	Sheet: 1 of 1
Drawn By: S.Yu	File: PMP21750.SchDoc	Sheet Title: US line to 3.3V/30mA	Size: B
Engineer: Jason Kriek	Contact: http://www.ti.com/support		http://www.ti.com



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